

IGBT Discrete with Anti-Parallel Diode

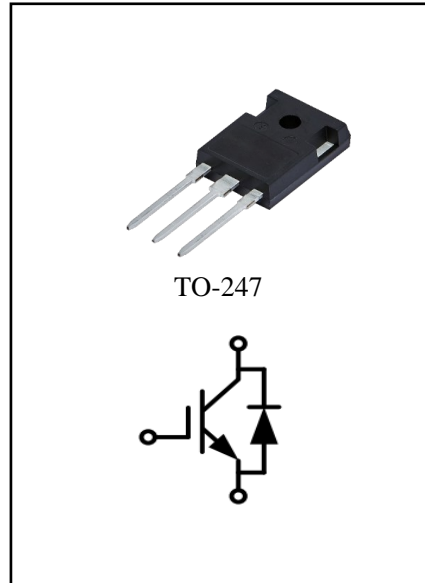
$V_{CES}=1200V$, $I_{C\ nom}=40A$ / $I_{CRM} =80A$

Features:

- 1200V Trench /Field Stop type
- Low switching losses
- V_{cesat} has A positive temperature coefficient

Applications

- Charging station
- UPS
- Inverters



IGBT

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^{\circ}C$	V_{CES}	1200	V
Continuous DC collector current	$T_C=100^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	40	A
Repetitive peak collector current	$t_p=1\ ms$	I_{CRM}	80	A
Total power dissipation	$T_C = 25^{\circ}C$, $T_{vj\ max} = 175^{\circ}C$	P_{tot}	270	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE}=15V, I_C=40A$ $V_{GE}=15V, I_C=40A$ $V_{GE}=15V, I_C=40A$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	V_{CEsat}	1.60 1.90 2.00	2.20	V
Gate-Emitter threshold voltage	$I_C=0.5mA, V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	$V_{GE(th)}$	4.8	5.5	6.2
Transconductance	$V_{CE}=20V, I_C=40A$		G_{fs}	27		S
Input capacitance			C_{ies}	2.56		nF
Output capacitance	$f=1\text{ MHz}, V_{CE}=25\text{ V}, V_{GE}=0\text{ V}$	$T_{vj}=25^{\circ}C$	C_{oes}	0.16		
Reverse transfer capacitance			C_{res}	0.12		
Collector-emitter cut-off current	$V_{CE}=1200V, V_{GE}=0\text{ V}$	$T_{vj}=25^{\circ}C$	I_{CES}		1	mA
Gate-emitter leakage current	$V_{CE}=0\text{ V}, V_{GE}=20\text{ V}$	$T_{vj}=25^{\circ}C$	I_{GES}		200	nA
Turn-on delay time	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=12\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ on}$	84 80 76		ns
Rise time	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=12\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_r	50 60 60		
Turn-off delay time	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=12\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ off}$	264 298 304		
Fall time	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=15\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_f	203 297 283		
Turn-on energy loss per pulse	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=12\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{on}	2.50 4.15 4.50		
Turn-off energy loss per pulse	$I_C=40A, V_{CE}=600\text{ V}$ $V_{GE}=\pm 15\text{ V}, R_G=12\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{off}	1.50 1.95 2.10		mJ
IGBT thermal resistance, junction			R_{thJC}	0.38		K/W
Temperature under switching conditions			$T_{vj\ op}$	-40	150	$^{\circ}C$

Diode

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$	V_{RRM}	1200	V
Continuous DC forward current	$T_C=100^{\circ}\text{C}$, $T_{vj\max}=175^{\circ}\text{C}$	I_F	8	A
Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	16	A

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=8\text{A}$, $V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$		1.73	2.8	V
	$I_F=8\text{A}$, $V_{GE}=0\text{V}$	$T_{vj}=125^{\circ}\text{C}$		1.53		
	$I_F=8\text{A}$, $V_{GE}=0\text{V}$	$T_{vj}=150^{\circ}\text{C}$		1.48		
Peak reverse recovery current	$I_F=8\text{A}$,	$T_{vj}=25^{\circ}\text{C}$		18		A
	$-di_F/dt=356\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$	$T_{vj}=125^{\circ}\text{C}$		22		
	$V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=150^{\circ}\text{C}$		25		
Reverse Recovered charge	$I_F=8\text{A}$,	$T_{vj}=25^{\circ}\text{C}$		2.45		μC
	$-di_F/dt=356\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$	$T_{vj}=125^{\circ}\text{C}$		3.38		
	$V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=150^{\circ}\text{C}$		3.73		
Reverse Recovery Time	$I_F=8\text{A}$,	$T_{vj}=25^{\circ}\text{C}$		186		ns
	$-di_F/dt=356\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$	$T_{vj}=125^{\circ}\text{C}$		207		
	$V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=150^{\circ}\text{C}$		218		
Reverse recovered energy	$I_F=8\text{A}$,	$T_{vj}=25^{\circ}\text{C}$		0.65		mJ
	$-di_F/dt=356\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$	$T_{vj}=125^{\circ}\text{C}$		0.88		
	$V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=150^{\circ}\text{C}$		0.95		
Diode thermal resistance, junction		R_{thJC}		0.45		K/W
Temperature under switching conditions		$T_{vj\text{op}}$	-40		175	$^{\circ}\text{C}$

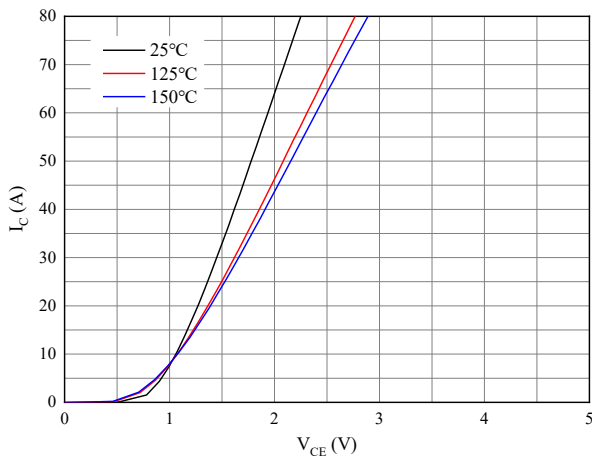


Fig 1. Typical output characteristics ($V_{GE}=15V$)

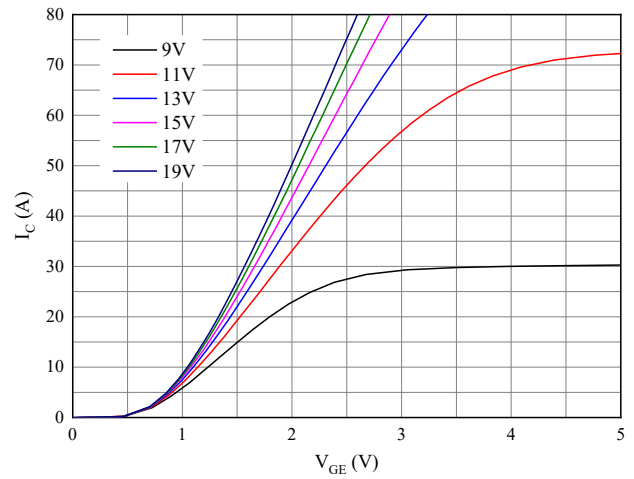


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

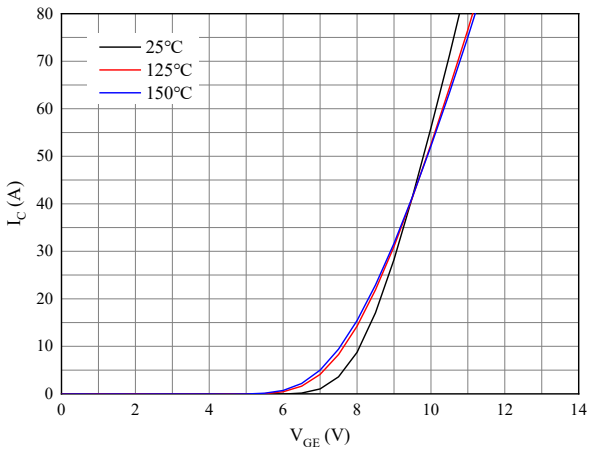


Fig 3. Typical transfer characteristic ($V_{CE}=20V$)

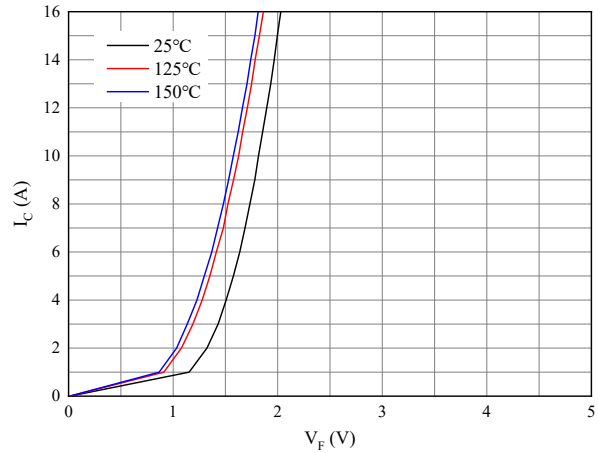


Fig 4. Forward characteristic of Diode

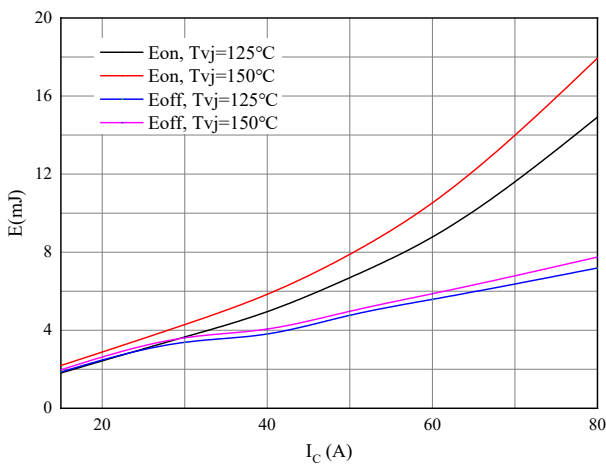


Fig 5. Switching losses of IGBT

$V_{GE}=\pm 15V, R_{Gon}=12\Omega, R_{Goff}=12\Omega, V_{CE}=600V$

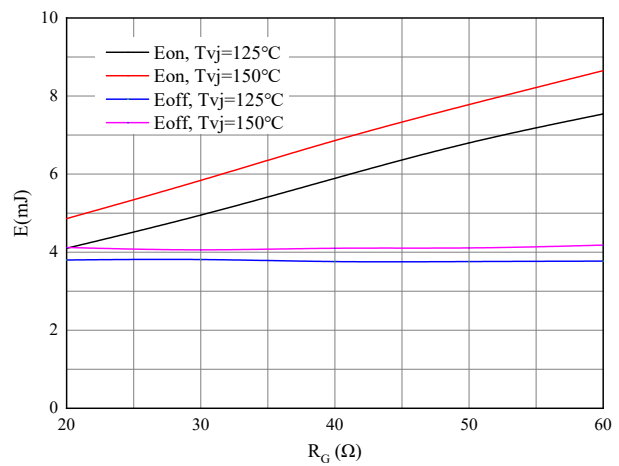


Fig 6. Switching losses of IGBT

$V_{GE}=\pm 15V, I_C=8A, V_{CE}=600V$

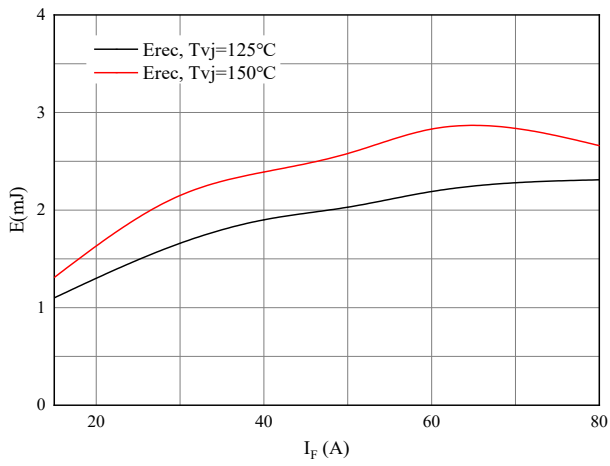


Fig 7. Switching losses of Diode

$R_{gon}=12\Omega$, $V_{CE}=600V$

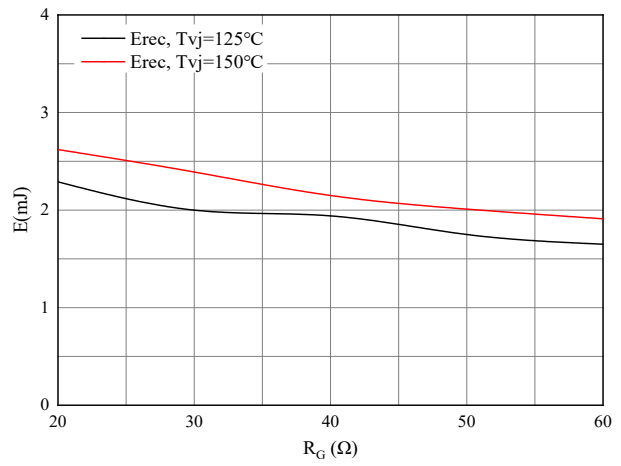


Fig 8. Switching losses of Diode

$I_F=8A$, $V_{CE}=600V$

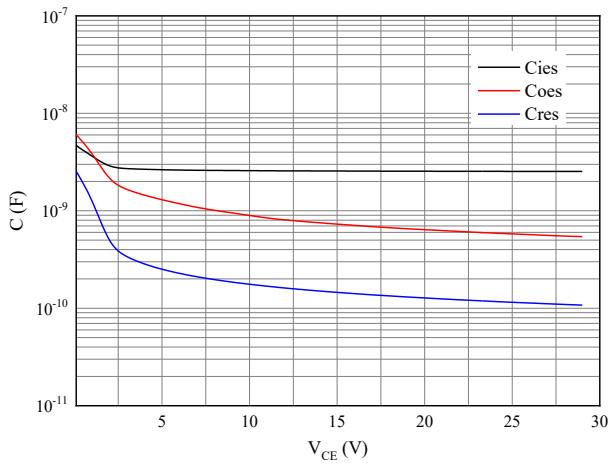
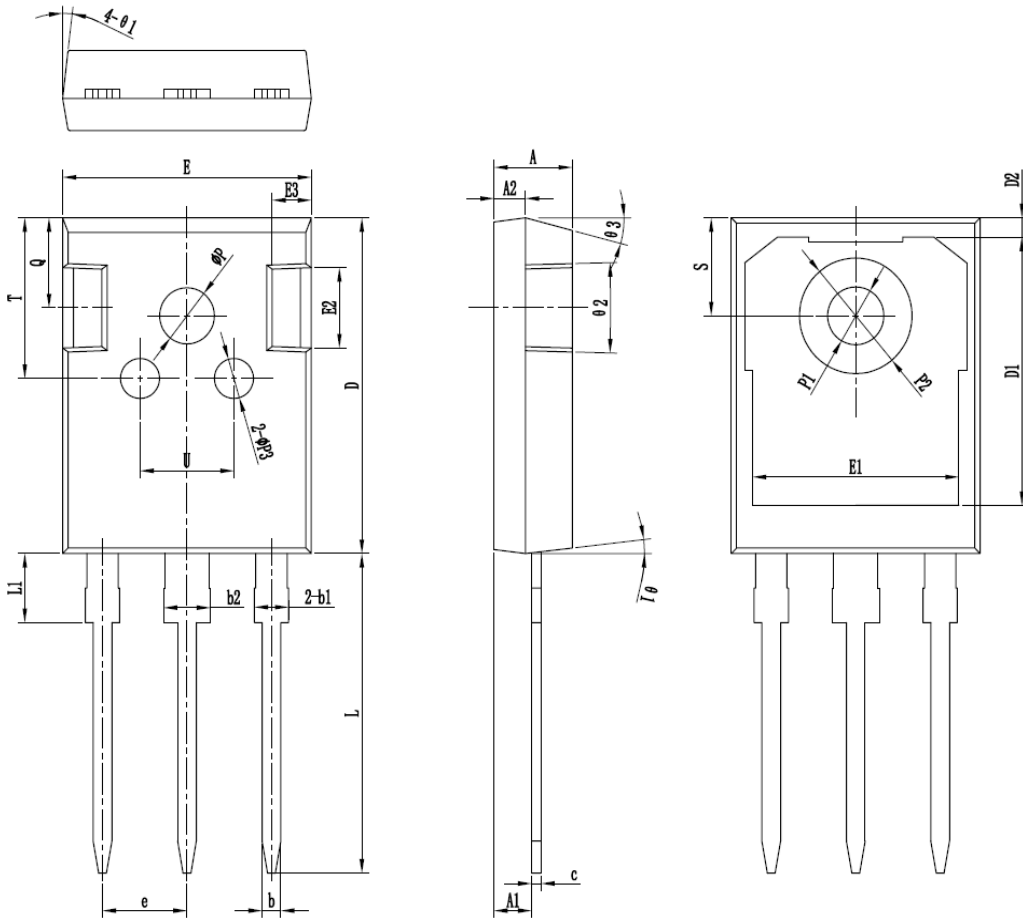


Fig 9. Capacitance characteristic

Package outlines



symbol	unit: mm		
	MIN	NOM	MAX
*A	4.90	5.00	5.10
*A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
*b	1.15	1.20	1.25
*b1	1.95	2.10	2.25
*b2	2.95	3.10	3.25
*c	0.55	0.60	0.65
*d	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35
*E	15.70	15.80	15.90
E1	13.10	13.25	13.40
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
*e	5.40	5.44	5.48
*L	19.80	19.92	20.10
*L1	-	-	4.30
*PP	3.70	3.80	3.90
*PP1	3.50	3.60	3.70
PP2	7.00	7.20	7.40
PP3	2.40	2.50	2.60
Q	5.60	5.80	6.00
*S	6.05	6.15	6.25
T	9.80	10.00	10.20
U	6.00	6.20	6.40
Ø1	5*	7*	9*
Ø2	1*	3*	5*
Ø3	13*	15*	17*